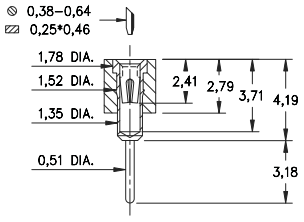


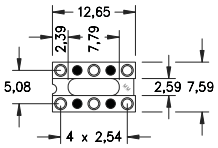


Fig. 1

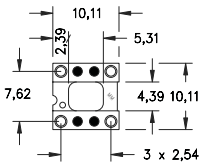


Fig. 2

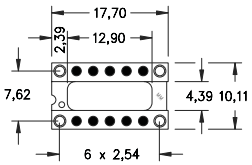


Fig. 3

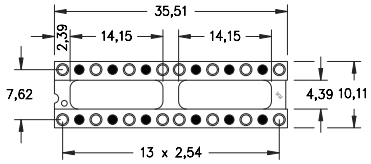
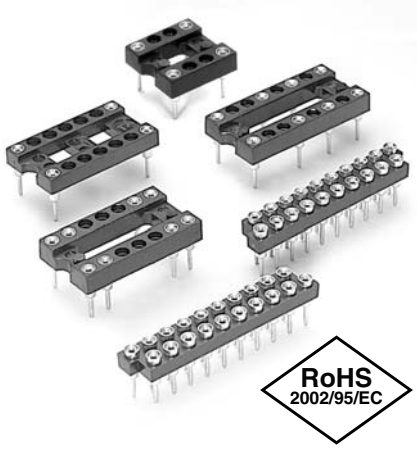


Fig. 4

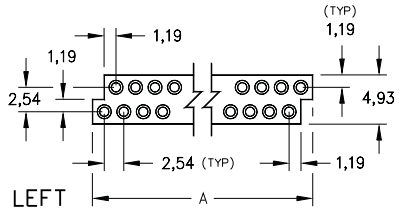
○ = Loaded Position ● = Empty Position

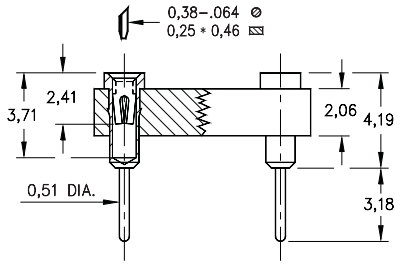
- Relay sockets accept devices with I/O pins on 2,54 grid.
- Additional Relay DIP socket patterns are available on Page 64.
- Zig-Zag strip sockets are suitable for IC's and memory chips with staggered double row patterns.
- Series 110 and 410 use MM #1001 receptacles. See page 136 for details.
- Receptacles use Hi-Rel, 4 finger #30 BeCu contact rated at 3 amps. See page 218 for details.
- Insulators are high temp. thermoplastic.

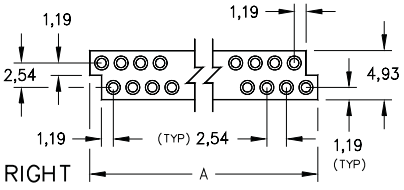


Selectively Loaded Sockets For Dual-In-Line Relays

	No. of pins	Ordering Information
Fig. 1	6	110-XX-210-10-001000
Fig. 2	4	110-XX-308-10-001000
Fig. 3	4	110-XX-314-10-001000
Fig. 4	16	110-XX-328-10-001000







Staggered (Zig-Zag) Strip Sockets

Dim 'A'	No. of pins	Insulator Body	Ordering Information
18,97	14	Left, Stackable	410-93-214-10-001000
18,97	14	Right, Stackable	410-93-214-10-002000
21,51	16	Left, Stackable	410-93-216-10-001000
21,51	16	Right, Stackable	410-93-216-10-002000
26,59	20	Left, Stackable	410-93-220-10-001000
26,59	20	Right, Stackable	410-93-220-10-002000
31,67	24	Left, Stackable	410-93-224-10-001000
31,67	24	Right, Stackable	410-93-224-10-002000
36,75	28	Left, Stackable	410-93-228-10-001000
36,75	28	Right, Stackable	410-93-228-10-002000

For Electrical, Mechanical & Enviromental Data, See pg. 4

XX=Plating Code See Below

For RoHS compliance select ◇ plating code.

SPECIFY PLATING CODE XX=	13◇		93			43◇	
Sleeve (Pin)	0,25µm Au		5,08µm Sn/Pb			5,08µm Sn	
Contact (Clip)	0,76µm Au		0,76µm Au			0,76µm Au	